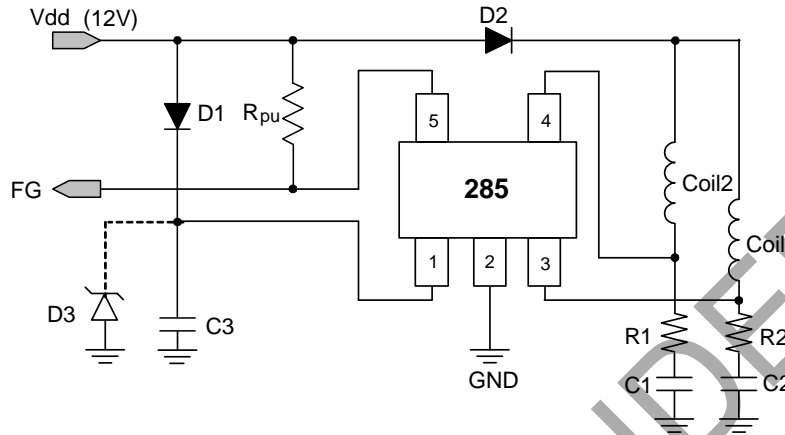


**Typical Application Circuit** (Note 4)



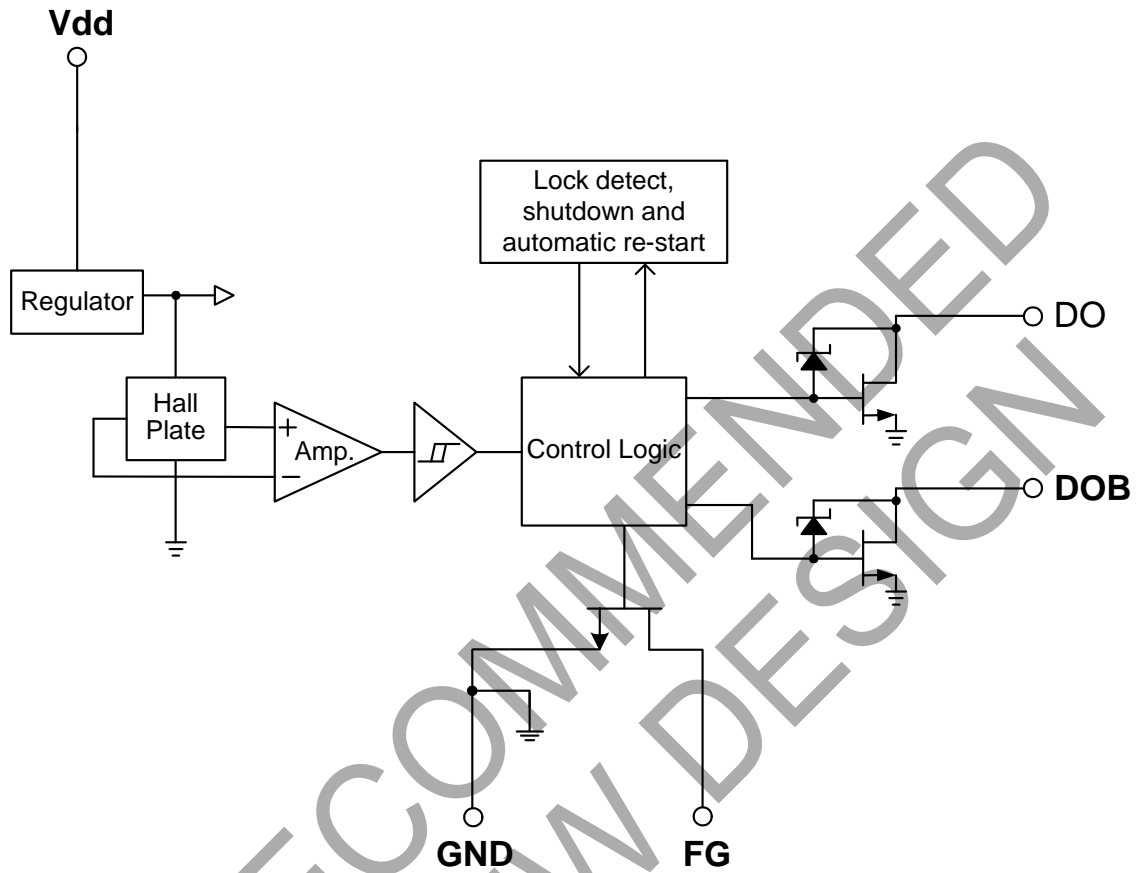
**12V DC Brush-less Fan with FG Output Function**

Notes: 4. Typically it is recommended to use a 56Ω resistor for R1 and R2 and a 2.2μF E-Cap capacitor for C1, C2 and C3. These values may need to be optimized depending on the coils used.  
To help with IC protection it's advised to add a Zener diode between Vdd and ground. The Zener diode should be chosen to help prevent the supply voltage exceeding the maximum rating of the device.

**Pin Descriptions**

Pin Name	Description
FG	Frequency Generation
Vdd	Input Power
DO	Output Pin
DOB	Output Pin
GND	Ground

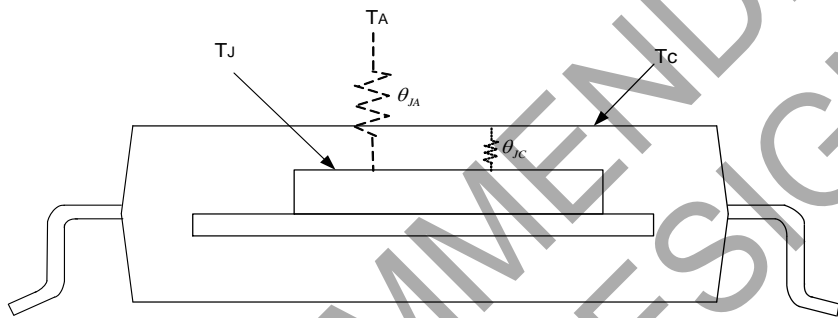
**Functional Block Diagram**



NOT RECOMMENDED FOR NEW DESIGN

**Absolute Maximum Ratings** ( $T_A = +25^\circ\text{C}$ )

Symbol	Characteristics	Rating	Unit
$V_{DD}$	Supply Voltage	24	V
$I_O$	Output Current	$I_O$ (AVE)	500 mA
		$I_O$ (PEAK)	700 mA
$P_D$	Power Dissipation	800	mW
$T_{ST}$	Storage Temperature	-55 to +150	$^\circ\text{C}$
$T_J$	Maximum Junction Temperature	+150	$^\circ\text{C}$
$\theta_{JA}$	Thermal Resistance Junction to Case (Note 5)	156	$^\circ\text{C}/\text{W}$



Note: 5.  $\theta_{JA}$  should be confirmed with heat sink thermal resistance. If there is no heat sink contact,  $\theta_{JA}$  will almost be the same as  $\theta_{JC}$ .

**Recommended Operating Conditions**

Symbol	Characteristic	Conditions	Min	Max	Unit
$V_{DD}$	Supply Voltage	Operating	3.8	20	V
$T_A$	Operating Ambient Temperature	Operating	-40	+100	$^\circ\text{C}$

**Electrical Characteristics** ( $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 12\text{V}$ , unless otherwise specified.)

Symbol	Characteristics	Conditions	Min	Typ.	Max	Unit
$I_{DD}$	Supply Current	Operating	-	2	4	mA
$I_{OFF}$	Output Leakage Current	$V_{OUT}=24\text{V}$	-	< 0.1	10	$\mu\text{A}$
$t_{RLP-ON}$	Rotor Lock Protection On Time	-	0.4	0.5	0.6	Sec
$t_{RLP-OFF}$	Rotor Lock Protection Off Time	-	2.4	3	3.6	Sec
$V_{OUT(SAT)}$	Output Saturation Voltage	$I_O = 300\text{mA}$	-	375	500	mV
		$I_O = 500\text{mA}$	-	625	900	
$R_{DS(ON)}$	Output On Resistance	$I_O = 300\text{mA}$	-	1.25	1.67	$\Omega$
$V_{OL}$	FG Output $V_{DS}$	$I_O = 10\text{mA}$	-	0.5	-	V
$V_Z$	Output Zener-Breakdown Voltage	-	35	42	60	V

**Truth Table**

IN-	IN+	CT	OUT1	OUT2	FG	Mode
H	L	L	H	L	H	Rotating
L	H	L	L	H	L	Rotating
-	-	H	Off	Off	-	Lockup protection activated

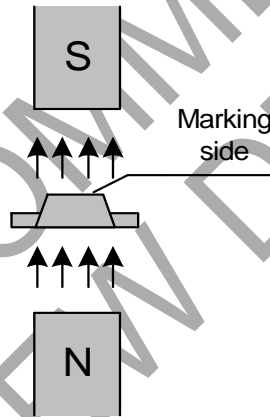
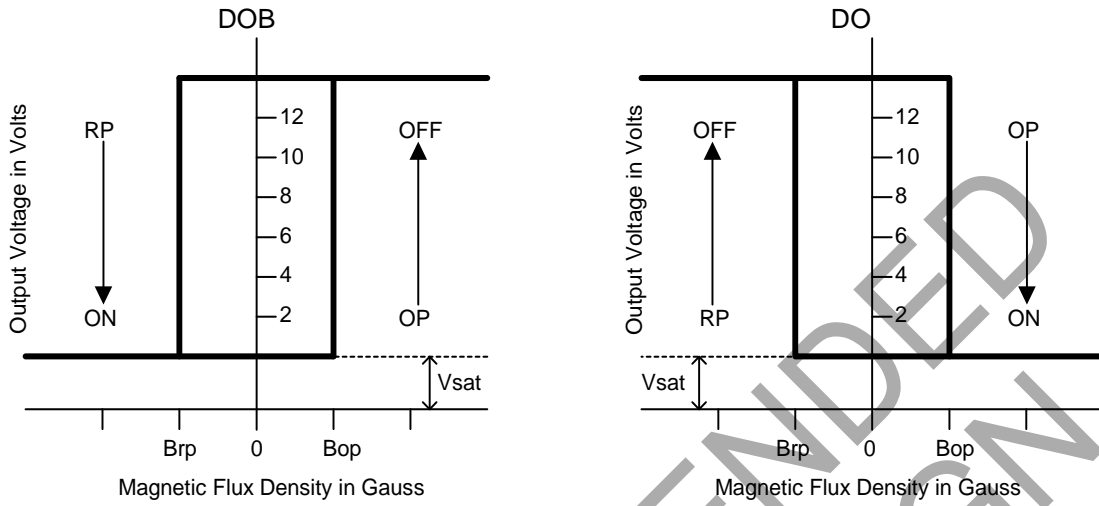
**Magnetic Characteristics** ( $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 12\text{V}$ , unless otherwise specified, Note 6)

(1mT = 10 Gauss)

Symbol	Characteristics	Min	Typ.	Max	Unit
Bop	Operation Point	10	30	60	Gauss
Brp	Release Point	-60	-30	-10	Gauss
Bhy	Hysteresis	-	60	-	Gauss

Note: 6. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

**Operating Characteristics**

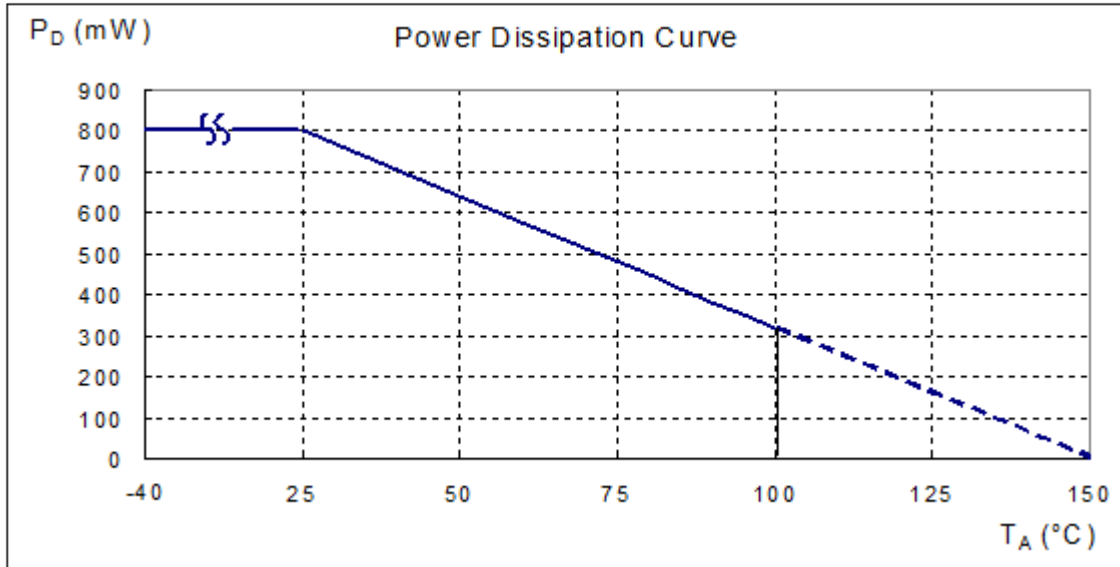


( SOT89-5 )

NOT RECOMMENDED FOR NEW DESIGN

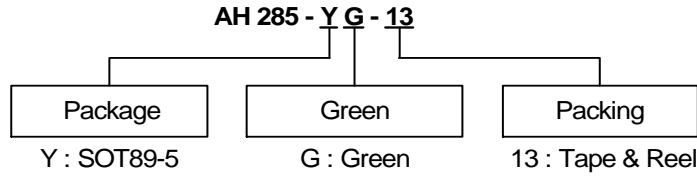
**Performance Characteristics**

$T_A$ (°C)	25	50	60	70	75	80	85	90	95	100
$P_D$ (mW)	800	640	576	512	480	448	416	384	352	320
$T_A$ (°C)	105	110	115	120	125	130	135	140	145	150
$P_D$ (mW)	288	256	224	192	160	128	96	64	32	0



NOT RECOMMENDED FOR NEW DESIGN

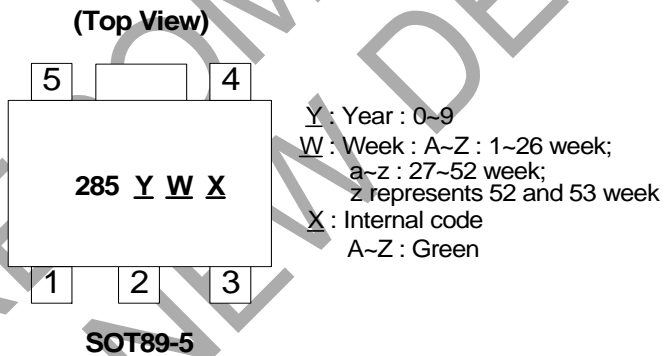
## Ordering Information



Device	Status (Note 9)	Package Code	Packaging (Note 7, 8)	Bulk		13" Tape and Reel	
				Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH285-YG-13	NRND	Y	SOT89-5	NA	NA	2500/Tape & Reel	-13

- Notes:
7. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
  8. Reverse taping as shown on Diodes Incorporated's Surface Mount (SMD) Packaging document AP02007, which can be found on our website <http://www.diodes.com/datasheets/ap02007.pdf>.
  9. NRND = Not Recommended for New Design.

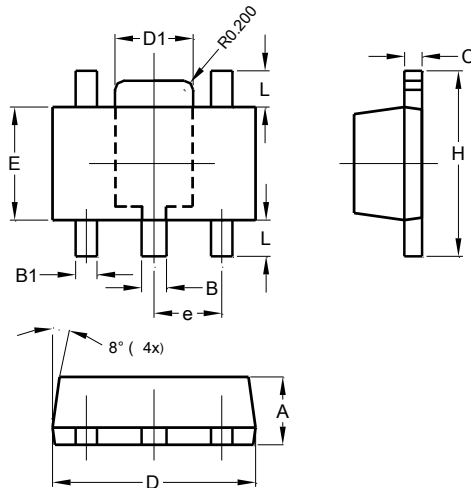
## Marking Information



**Package Outline Dimensions (All Dimensions in mm)**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT89-5

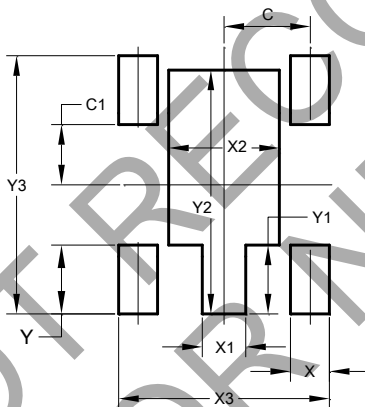


SOT89-5			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
B	0.50	0.62	0.56
B1	0.44	0.54	0.48
C	0.35	0.43	0.38
D	4.40	4.60	4.50
D1	1.62	1.83	1.733
E	2.40	2.60	2.50
e	-	-	1.50
H	3.95	4.25	4.10
L	0.65	0.95	0.80
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT89-5



Dimensions	Value (in mm)
C	1.500
C1	1.050
X	0.680
X1	0.760
X2	1.930
X3	3.680
Y	1.200
Y1	1.200
Y2	4.250
Y3	4.500



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